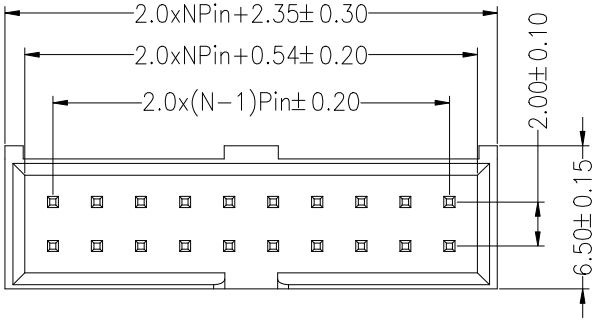
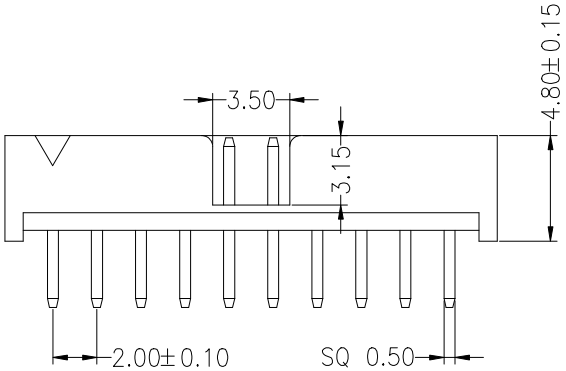
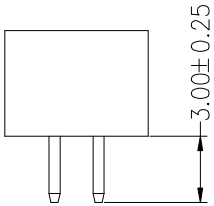
HSF RoHS FILE NO :E362810

SPECIFICATIONS
Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard:High temperature material
Soldering temperature:260°C±5° 5S



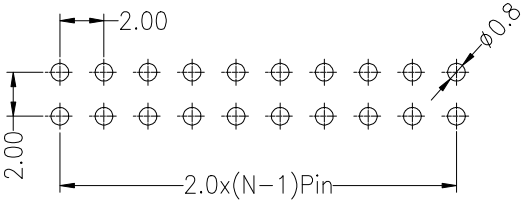




Ordering Information

3224 XX S XX X B K00 X 0X

- XX: No.of Pins 6−−64
- XX: Contact Plating
  G1:Gold Flash
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  G6:10U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X: Insulator Material Option
  C=BK−PA6T
  F=BK−LCP
- X: Packing
  A=Tray
  T=Tube



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2015.04.14	NEW DRAWING	

OPERATION		DRAW	Liu Miao	15.04.14	SCALE	FIT
X.X	± 0.30				UNIT	mm
X.XX	± 0.20	CHECK			SIZE	A4
X.XXX	± 0.10				SHEET	1/1
Angle	± 3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3224XXSXXXBK00X0X
TITLE:	2.0Box Header Npin H4.8 180°